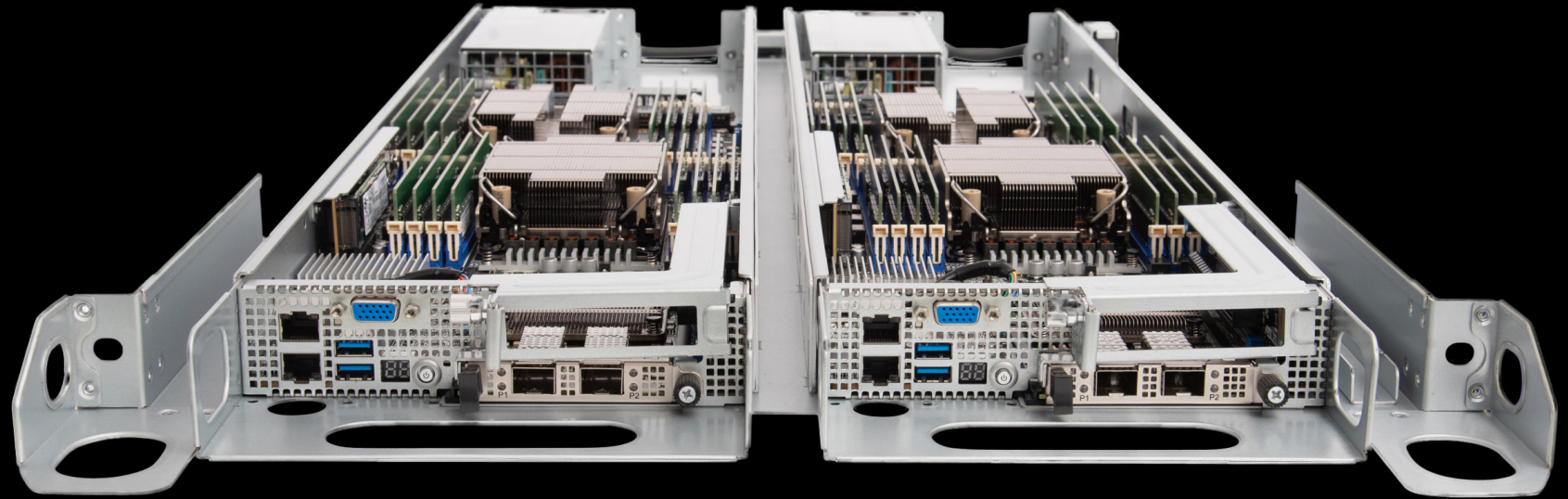


TRIDENT iCX610DR-G5

immersion server



intel
partner
Titanium

intel.
XEON
PLATINUM



Perfect for

- › HPC
- › Rendering
- › Edge Computing
- › AI
- › Machine Learning
- › Deep Learning

Purpose-Built and Optimized

Looking for a sustainable ultra-high density, scalable system to meet the evolving demands of your critical high-performance computing needs? The 3rd Gen Intel® Xeon® Scalable powered CIARA TRIDENT iCX610DR-G5 immersion server is purpose-built for single-phase immersion cooling technology. It offers flexible support for up to 2 hot-swappable dual-socket compute nodes in a 1U chassis with up to 4 TB of DDR4-3200 MHz memory per node.

Performance and Reliability

We are driven by our need to continuously improve performance on our servers. Our turbo-locked features guarantee superior performance, without sacrificing reliability or hardware lifespan. It is perfect for HPC workloads in industries like edge computing, digital manufacturing, media and entertainment, financial services and AI.

Serviceability and Warranty

For improved serviceability and uptime, the CIARA TRIDENT iCX610DR-G5 compute nodes can be maintained without impacting operation of other nodes in the same chassis. We offer optimal RAS features that help you save on service costs, reduce server downtime, and allow flexibility and ease to adapt to new generations of technology when the time comes.



The Unrivalled Benefits of Immersion Cooling

Immersion cooling has a huge number of benefits, especially when it comes to sustainability and efficiency. It significantly reduces the amount of water used, levels of carbon emissions, and much more.

95%
**Reduction in
Cooling OPEX**

> PUE of 1.03 (certified by a 3rd party).
ROI of less than 1 year even only
considering the electricity savings.

10x
**Increase in Server
Density**

> Dissipation capacity of up to almost
100 kW in the space of two standard
racks.

50%
**CAPEX Reduction
Build Costs**

> Rapidly deployable in raw space
without need for raised floors nor
cold aisles. Minimum retrofitting
required for existing data centers.

60%
**Increase in
Hardware Lifespan**

> No moving parts, no dust particles,
no vibrations, less thermal and
mechanical stress due to the
uniformity provided by the liquid
and its viscosity.

99%
**Heat Captured
in Form of Warm
Water**

> Allows for unprecedented energy
reuse if data centers are built
close to communities or industry
potentially creating new revenue
streams.

0%
**Water
Consumption**

> The closed loop of the secondary
cooling system guarantees no
corrosion, health risks (legionella)
and prevents any water evaporation.



1U 2-Node Intel® (Custom Designed for Immersion Cooling) - Chassis

Product Category	High Density Compute Server
Form Factor	2 hot-swappable dual-socket compute nodes in a 1U chassis
Cooling System	Single-Phase Immersion Cooling
Power Supply	Included in Node
Dimensions (L x W x H)	33.26" x 17.71" x 1.71" 845mm x 450mm x 43.5mm
Estimated Weight	43.7 lb / 19.9 kg

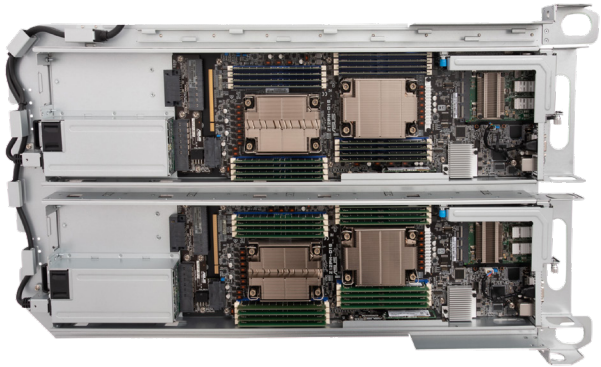
Node Specifications

Processor	Dual 3rd Gen Intel® Xeon® Scalable Processors, TDP up to 270W
Heatsink	Immersion Cooling Custom Heatsink
TIM	Indium Foil
Memory	Up to 4,096 GB (16 x DIMM) DDR4-3200 MHz 8-channel memory architecture Supports RDIMM, LRDIMM, 3DS RDIMM/LRDIMM
Network Controller	Intel® I210-AT Single-Port 1GbE 1GBASE-T Single-Port Dedicated Management 1GbE 1 GBASE-T
Storage	(2) Fixed 2.5" SATA HDD (2) M.2 SSD up to 22110 (PCIe/SATA)
Expansion Slots	(1) PCIe 4.0 x16 HHHL (1) OCP 3.0 PCIe 4.0 x16 mezzanine
GPU/FPGA Capabilities	N/A or (1) if HH/HL
GPU/FPGA Support	Upon Request
I/O Rear	(2) USB 3.0, (1) VGA, (1) RJ45 MLAN, (1) RJ45 Gbe Lan, (1) Power Switch, (1) Q-code / Port 80 LED
Management	Aspeed® AST2600 BMC
Power Supply	(1) Fixed 1200W AC - 80 PLUS Platinum Power Supply
OCP Availability	Yes (Q3 2022)

Operating Temperatures	10°C~ 50°C
OS Support	Windows Server 2019, Red Hat Enterprise Linux 8.3 (x64) or later, SUSE Linux Enterprise Server 15 SP2 (x64) or later, Ubuntu 20.04.1 LTS (x64) or later, VMware ESXi 7.0 Update 2 or later

Single-Phase Immersion Cooling Capacity

Max Nodes Capacity per Pod	
Submer MicroPod	12 Nodes - 500 W Max per Node
Submer SmartPodXL	84 Nodes - 600 W Max per Node
Submer SmartPod XL+	84 Nodes - 1200 W Max per Node
Submer SmartPod XL+ (48U)	96 Nodes - 1000 W Max per Node



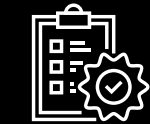
The 360° Hypertec Made-For-Immersion Solution

We bring a full 360° solution so all you need to do is sit back and enjoy all the benefits without the headache and save on OPEX and CAPEX. Our professional services enhance your IT journey by reducing time, TCO, effort and resources.

Want to learn more or need help?

- › Contact Sales
- › Immersion Cooling Solutions
- › Hypertec Cloud Services
- › Hypertec Support Center
- › Support Services & Warranty
- › Sustainability

Learn more



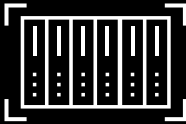
Site
Assessment



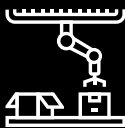
Power
Budget



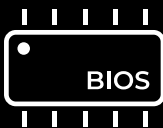
Installation
Planning



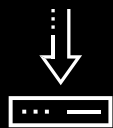
Tank & Pod
Layout



Factory
Assembly



BIOS & Firmware
Settings



Software & OS
Installation



Customer
Image



Onsite
Installation



Cabling &
Labeling



Networking &
Power



Global Warranty &
Service

Limited Warranty

Hardware warranty includes a one year, parts and labour with return to Hypertec USA or Canada. Customers may purchase an extended warranty of up to 5 years on parts and labour with different support levels. For additional information regarding worldwide limited warranty and technical support, please visit: <https://hypertec.com/support-services-policy/>.